SiHF23N60E

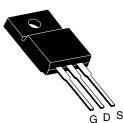
Vishay Siliconix

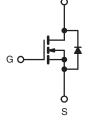


E Series Power MOSFET

PRODUCT SUMMA	RY			
V _{DS} (V) at T _J max.	650)		
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.158		
Q _g max. (nC)	95			
Q _{gs} (nC)	16			
Q _{gd} (nC)	25			
Configuration	Sing	le		

TO-220 FULLPAK





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF23N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	v	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current (T _{.1} = 150 °C) $^{\circ}$	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		23		
Continuous Drain Current $(1_j = 150^{\circ} C)^{\circ}$	V _{GS} at 10 V	T _C = 100 °C	I _D	15	А	
Pulsed Drain Current ^a			I _{DM}	63		
Linear Derating Factor				0.28	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	353	mJ	
Maximum Power Dissipation			PD	35	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-1) / /-14	37		
Reverse Diode dV/dt ^d		dV/dt	34	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

e. Limited by maximum junction temperature.

S15-0277-Rev. C, 23-Feb-15

1 For technical questions, contact: <u>hvm@vishay.com</u>





Vishay Siliconix

PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
		11F.		65				
Maximum Junction-to-Ambient	R _{thJA}	-		3.6			°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		3.0				
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	•							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.72	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
Cata Source Leekage		$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zaro Gata Valtago Drain Current	1-	V _{DS} =	= 600 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 \	/, V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I	_D = 12 A	-	0.132	0.158	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D :	= 12 A	-	6.4	-	S
Dynamic								
Input Capacitance	C _{iss}		V _{GS} = 0 V		-	2418	-	
Output Capacitance	C _{oss}		$V_{DS} = 100$	V,	-	119	-	
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MH:	2	-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		(1. 400.)(-	107	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	/ to 480 V,	v _{GS} = 0 v	-	320	-	
Total Gate Charge	Qg				-	63	95	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 12	A, V _{DS} = 480 V	-	16	-	nC
Gate-Drain Charge	Q _{gd}				-	25	-	
Turn-On Delay Time	t _{d(on)}		•		-	22	44	
Rise Time	t _r	V _{DD} =	= 480 V, I _D	= 12 A,	-	38	76]
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	66	99	ns	
Fall Time	t _f]			-	34	68	
Gate Input Resistance	Rg	f = 1	MHz, ope	n drain	-	0.73	-	Ω
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET sym showing the	bol		-	-	23	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	63	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 12 A	A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}				-	384	768	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, $I_F = I_S$	s = 12 A,	-	6.4	12.8	μ
Reverse Recovery Current	I _{RRM}	di/dt =	100 A/µs,	v _R = 25 v	-	30	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



SiHF23N60E

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

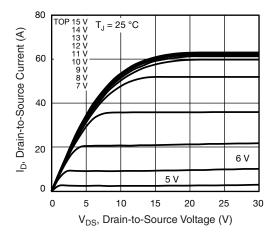


Fig. 1 - Typical Output Characteristics

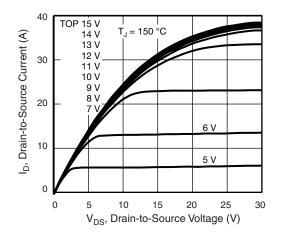
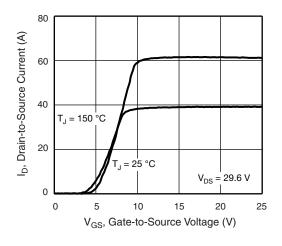


Fig. 2 - Typical Output Characteristics





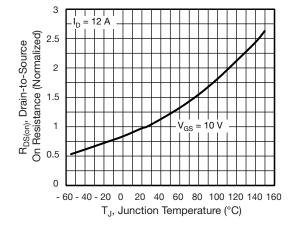


Fig. 4 - Normalized On-Resistance vs. Temperature

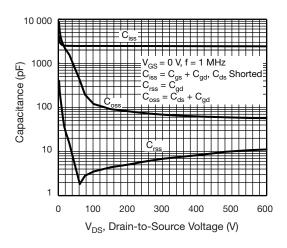


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

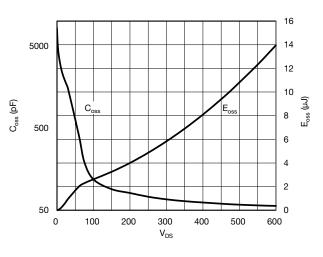


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

Document Number: 91553

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



SiHF23N60E

Vishay Siliconix

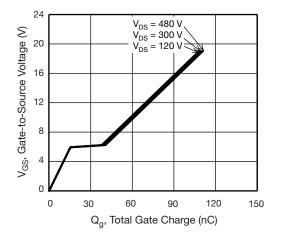


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

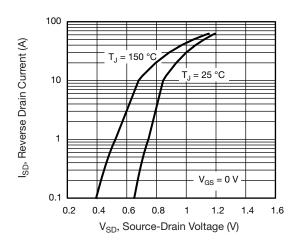


Fig. 8 - Typical Source-Drain Diode Forward Voltage

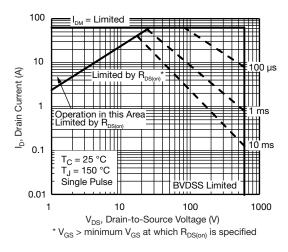


Fig. 9 - Maximum Safe Operating Area

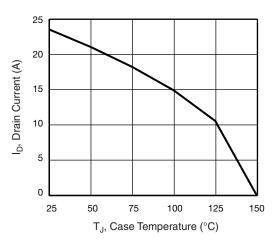


Fig. 10 - Maximum Drain Current vs. Case Temperature

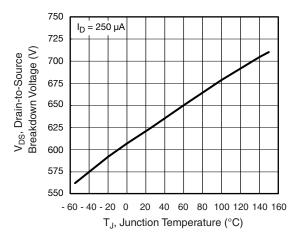


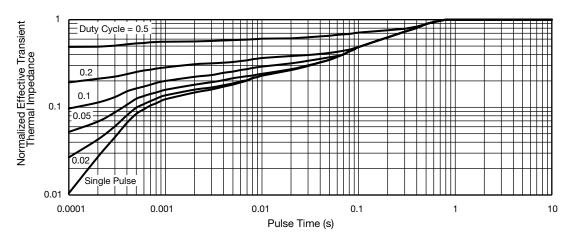
Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix





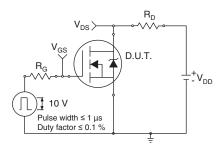


Fig. 13 - Switching Time Test Circuit

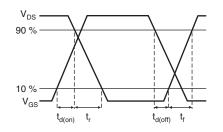


Fig. 14 - Switching Time Waveforms

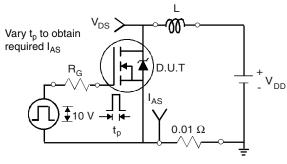


Fig. 15 - Unclamped Inductive Test Circuit

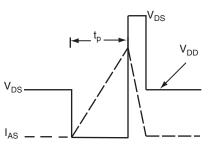


Fig. 16 - Unclamped Inductive Waveforms

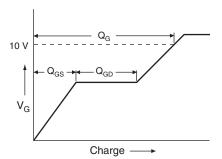


Fig. 17 - Basic Gate Charge Waveform

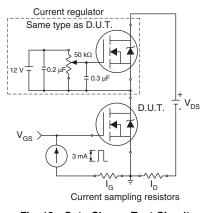


Fig. 18 - Gate Charge Test Circuit

S15-0277-Rev. C, 23-Feb-15

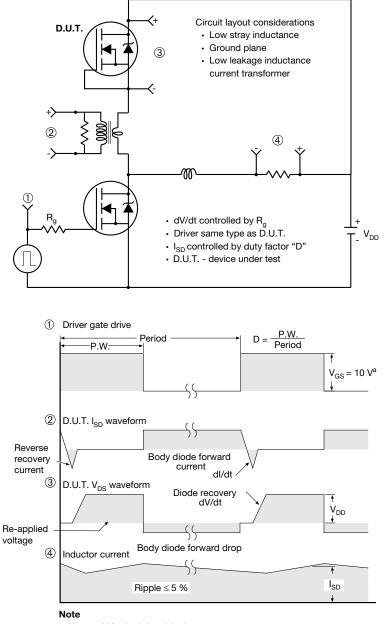
5

Document Number: 91553

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

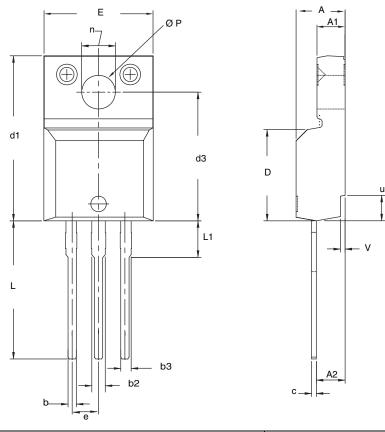
Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91553.

Package Information

Vishay Siliconix

TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$.

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SiHF23N60E-GE3